DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

PHOTOLINKER MACROMOLECULES, METALLIC SUBSTRATES AND LIGANDS MODIFIED WITH SAID LINKERS, AND PROCESS OF PREPARATION THEREOF

the specificati	on of which is attached hereto un	less the following is checl	ked			
was filed of International A	on as United States Applic Application Number <u>PCT/CH20</u>	ation Number and 04/000704 and was amend	was filed on 23 NOVEMB ded on (if applicable	ER 2004 as PCT).		
I hereby state claim(s), as an	that I have reviewed and underst nended by any amendment referr	and the contents of the about above.	ove-identified specification,	including the		
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pater	ntability as defined in Title	37, Code of Federal		
I hereby claim for patent or in inventor's cert	foreign priority benefits under Taventor's certificate listed below ificate having a filing date before	itle 35, United States Coc and have also identified be that of the application fo	le, § 119 (a) – (d) of any for elow any foreign applicatio r which priority is claimed.	reign application(s) n for patent or		
			•	Priority Claimed		
(List prior foreig applications. See note A)		EPO (Country)	28 NOV. 2003	⊠ Yes □ No		
	(Number)		(Day/Month/Year Filed)			
والهوولين والمستحد المتضيحة المراوعوا	The second secon		The second section of the second section of the second section of the second section s	☐ Yes ☐ No		
	(Number)	(Country)	(Day/Month/Year Filed)			
		. •		Yes No		
	(Number)	(Country)	(Day/Month/Year Filed)			
	•					
	(Number)	(Country)	(Day/Month/Year Filed)	∐ Yes ∐ No		
(See note B)	See attached list for additional		` *			
I hereby claim insofar as the s in the manner information wl § 1.56 which b date of this app	the benefit under Title 35, Units subject matter of each of the clain provided by the first paragraph itch is material to patentability as ecame available between the filiblication.	ed States Code, § 120 of a ms of this application is of Title 35, United States s defined in Title 37, Code ng date of the prior applic	any United States application of disclosed in the prior Un Code, § 112, I acknowledge of Federal Regulations, eation and the national or Post	on(s) listed below and, ited States application the the duty to disclose CT international filing		
(List prior U.S.						
Applications)			Patented Pend	ling Abandoned		
	(Application Serial No.)	(Filing Date)				
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned			
	(Application Serial No.)	(Filing Date)	Patented Pending Abandoned			
	(Application Serial No.)	(Filing Date)	Patented Pend	ing Abandoned		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

See note C)	Full name of sole or first inventor (given name, family name)		Hans SIGRIST	
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	Post Office Address		- —	
	Full name of fifth invelors signature	entor (given name, family name)		
	Residence		Date	
	Post Office Address		Citizenship —	
	Full name of sixth inv	entor (given name, family name)	Date	
	Residence		Citizenship	
	Post Office Address			
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